



No. 18-1

BEST POSTER AWARD

is presented to

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Title: Silanization-assisted surface metallization of silicon

at the 16th International Symposium on
Microelectronics and Packaging 2018

26th October, 2018

The Korean Microelectronics and Packaging Society

Yong Chul Park, President

A handwritten signature in black ink, appearing to read 'Yong Chul Park', is written below the printed name.